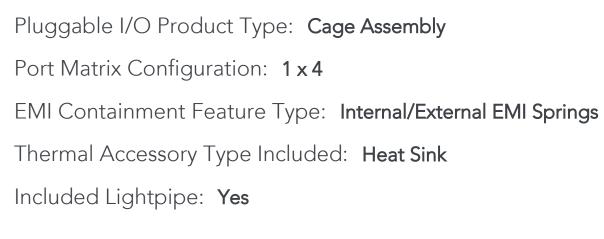
2170747-6 - ACTIVE

zQSFP+/QSFP28 TE Internal #: 2170747-6 QSFP, QSFP+ & zQSPF+, Cage Assembly, 1 x 4, Internal/External EMI Springs, Included Lightpipe, Standard, Data Rate (Max) 28 Gb /s, zQSFP+/QSFP28

View on TE.com >





Features

Product Type Features

| Form Factor | QSFP28/56 |
|-------------------------------------|-----------------------|
| Cage Туре | Ganged |
| Pluggable I/O Product Type | Cage Assembly |
| Thermal Accessory Type Included | Heat Sink |
| Connector System | Cable-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| Configuration Features | |
| Port Matrix Configuration | 1 × 4 |
| Number of Ports | 4 |
| Lightpipe Configuration | Single Round |
| Number of Rear EONs per Port Column | 0 |
| Electrical Characteristics | |
| Data Rate (Max) | 28 Gb/s |
| Body Features | |
| Heat Sink Finish | Anodized Black |
| Heat Sink Style | Pin |



QSFP, QSFP+ & zQSPF+, Cage Assembly, 1 x 4, Internal/External EMI Springs, Included Lightpipe, Standard, Data Rate (Max) 28 Gb/s, zQSFP+/QSFP28



| Heat Sink Height Class | Networking |
|---|---|
| Heat Sink Height | 13.5 mm[.531 in] |
| Contact Features | |
| PCB Contact Termination Area Plating Material | Tin |
| Termination Features | |
| Termination Post & Tail Length | 2.05 mm[.081 in] |
| Termination Method to Printed Circuit Board | Through Hole - Press-Fit |
| Mechanical Attachment | |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Cage Material | Nickel Silver |
| Dimensions | |
| PCB Thickness (Recommended) | 1.57 mm[.062 in] |
| Usage Conditions | |
| Operating Temperature Range | -40 – 85 °C[-40 – 185 °F] |
| Operation/Application | |
| Heat Sink Compatible | Yes |
| For Use With Pluggable I/O Products | QSFP28 Cable Assembly, QSFP28 MSA Compatible Transceiver |
| Pluggable I/O Applications | SFP+ Stacked Belly-to-Belly |
| Circuit Application | Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Method | Box & Tray |
| Other | |
| EMI Containment Feature Type | Internal/External EMI Springs |
| Included Lightpipe | Yes |
| Enhancements | Standard |
| | |

Product Compliance

For compliance documentation, visit the product page on TE.com>

QSFP, QSFP+ & zQSPF+, Cage Assembly, 1 x 4, Internal/External EMI Springs, Included Lightpipe, Standard, Data Rate (Max) 28 Gb/s, zQSFP+/QSFP28

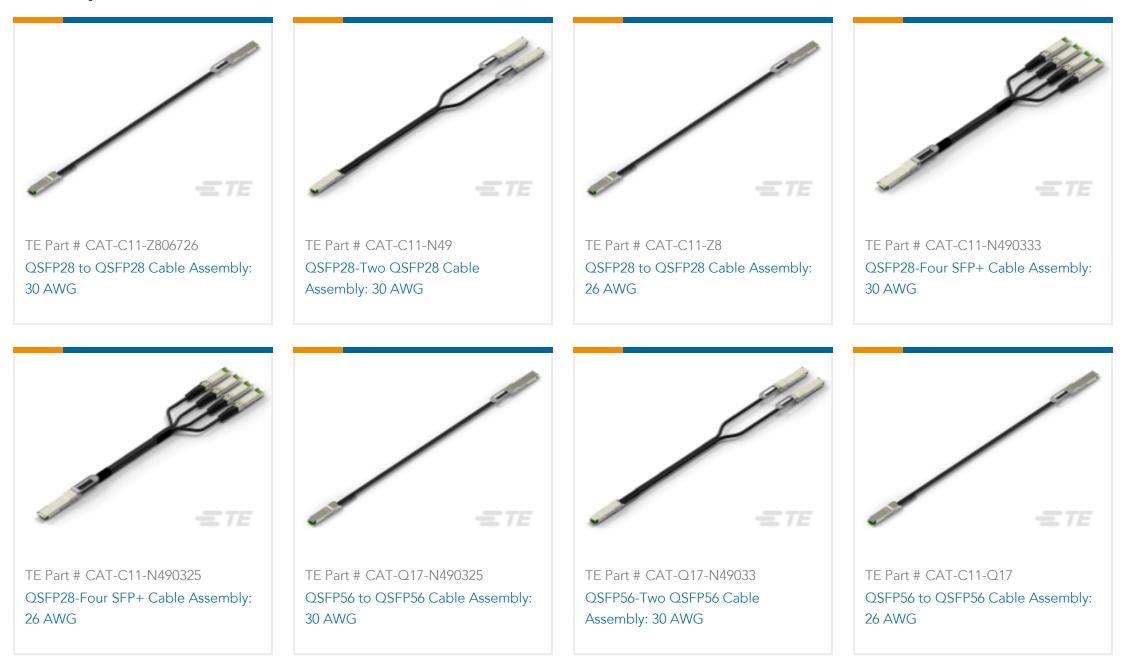


| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Not applicable for solder process capability |

Product Compliance Disclaimer

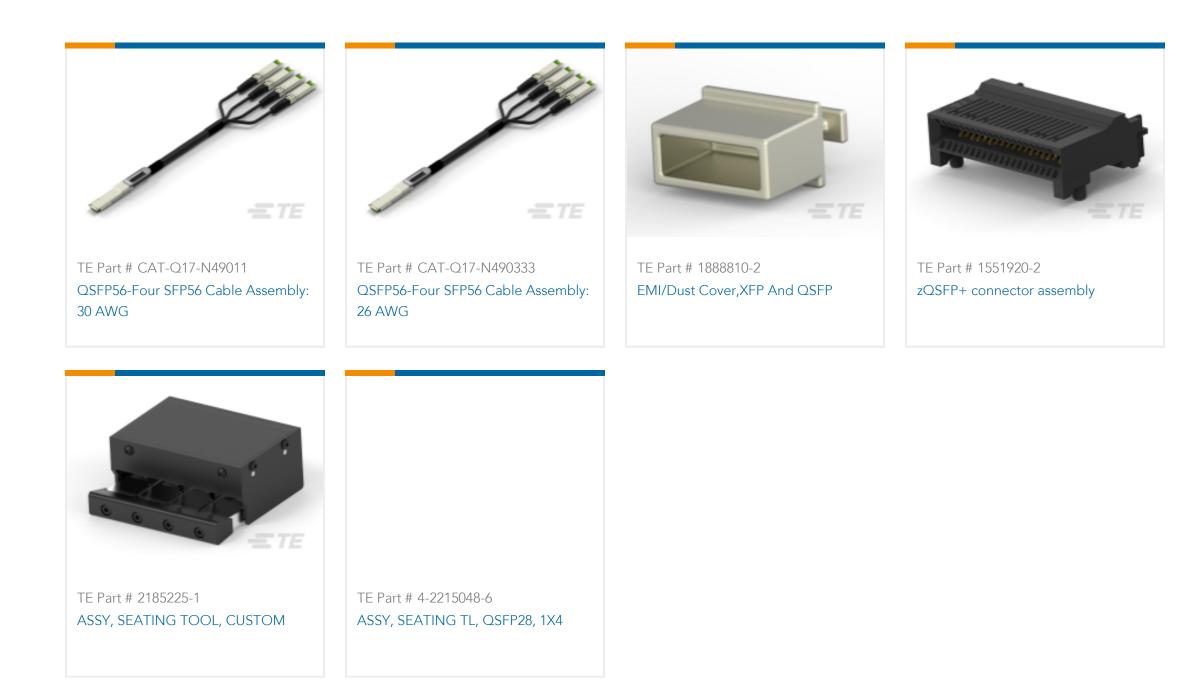
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

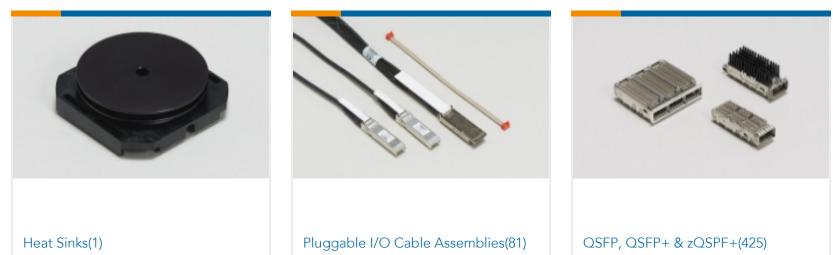


QSFP, QSFP+ & zQSPF+, Cage Assembly, 1 x 4, Internal/External EMI Springs, Included Lightpipe, Standard, Data Rate (Max) 28 Gb/s, zQSFP+/QSFP28





Also in the Series | zQSFP+/QSFP28



Customers Also Bought



QSFP, QSFP+ & zQSPF+, Cage Assembly, 1 x 4, Internal/External EMI Springs, Included Lightpipe, Standard, Data Rate (Max) 28 Gb/s, zQSFP+/QSFP28



Documents

Product Drawings CAGE ASSY, 1X4, QSFP28, SPRING, HS, LP

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_2170747-6_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2170747-6_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2170747-6_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

Datasheets & Catalog Pages QSFP28/56 and zQSFP+ Interconnects

English

Product Specifications Application Specification

English

Product Environmental Compliance

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